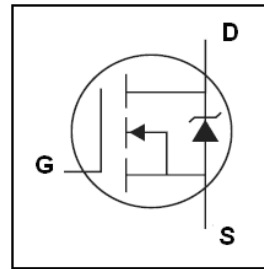


Features

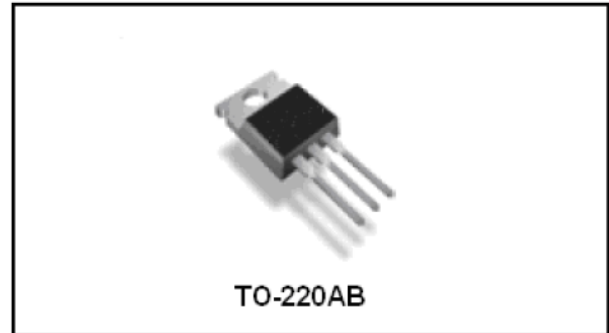
- ◆ Low On-Resistance
- ◆ Fast Switching
- ◆ 100% Avalanche Tested
- ◆ Repetitive Avalanche Allowed up to Tjmax
- ◆ Lead-Free, RoHS Compliant

Description

VS3107AT designed by the trench processing techniques to achieve extremely low on-resistance. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Motor applications and a wide variety of other applications.



| | |
|--------------|---------------|
| V_{DSS} | 80V |
| $R_{DS(on)}$ | 3.0m Ω |
| I_D | 190A |


Absolute Maximum Ratings

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

| Symbol | Parameter | Rating | Unit | |
|--|---|--------------------|------|------|
| Common Ratings (Tc=25°C Unless Otherwise Noted) | | | | |
| V_{GS} | Gate-Source Voltage | ±25 | V | |
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | 80 | V | |
| T_J | Maximum Junction Temperature | 175 | °C | |
| T_{STG} | Storage Temperature Range | -55 to 155 | °C | |
| I_S | Maxium Diode Continuous Forward Current | $T_C = 25^\circ C$ | 190 | A |
| Mounted on Large Heat Sink | | | | |
| I_{DM} | Pulse Drain Current Tested ① | $T_C = 25^\circ C$ | 750 | A |
| I_D | Continuous Drain current@VGS=10V | $T_C = 25^\circ C$ | 190 | A |
| P_D | Maximum Power Dissipation | $T_C = 25^\circ C$ | 350 | W |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case | | 0.41 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient | | 62.5 | °C/W |
| Drain-Source Avalanche Ratings | | | | |
| EAS | Avalanche Energy, Single Pulsed ② | | 950 | mJ |

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Unit |
|---|---|---|------|------|------|------|
| Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated) | | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V I _D =250μA | 80 | 85 | -- | V |
| I _{DSS} | Zero Gate Voltage Drain Current(Tc=25°C) | V _{DS} =75V,V _{GS} =0V | -- | -- | 1 | μA |
| | Zero Gate Voltage Drain Current(Tc=125°C) | V _{DS} =75V,V _{GS} =0V | -- | -- | 100 | μA |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} =±20V,V _{DS} =0V | -- | -- | ±100 | nA |
| V _{GS(TH)} | Gate Threshold Voltage | V _{DS} =V _{GS} ,I _D =250μA | 2.0 | 3.0 | 4.0 | V |
| R _{DS(ON)} | Drain-Source On-State Resistance ^③ | V _{GS} =10V, I _D =80A | -- | 3.0 | 4.2 | mΩ |
| g _{fs} | Forward Transconductance | V _{DS} = 10V, I _D =15A | -- | 50 | -- | S |
| Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated) | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =40V,V _{GS} =0V, f=1MHz | -- | 6250 | -- | pF |
| C _{oss} | Output Capacitance | | -- | 1500 | -- | pF |
| C _{rss} | Reverse Transfer Capacitance | | -- | 600 | -- | pF |
| Q _g | Total Gate Charge | V _{DS} =30V,I _D =40A, V _{GS} =10V | -- | 150 | -- | nC |
| Q _{gs} | Gate-Source Charge | | -- | 30 | -- | nC |
| Q _{gd} | Gate-Drain Charge | | -- | 40 | -- | nC |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-on Delay Time | V _{DD} =40V, I _D =1A, R _G =6.8Ω, V _{GS} =10V | -- | 26 | -- | nS |
| t _r | Turn-on Rise Time | | -- | 180 | -- | nS |
| t _{d(off)} | Turn-Off Delay Time | | -- | 50 | -- | nS |
| t _f | Turn-Off Fall Time | | -- | 96 | -- | nS |
| Source- Drain Diode Characteristics @ T_J = 25°C (unless otherwise stated) | | | | | | |
| I _{SD} | Source-drain current(Body Diode) | T _c =25°C | -- | -- | 160 | A |
| V _{SD} | Forward on voltage | I _{SD} =80A,V _{GS} =0V | -- | 0.84 | 1.3 | V |
| t _{rr} | Reverse Recovery Time | T _J =25°C,I _{sd} =75A, V _{GS} =0V | -- | 70 | -- | nS |
| Q _{rr} | Reverse Recovery Charge | di/dt=100A/μs | | 125 | | nC |

NOTE:

- ① Pulse width ≤ 300μs; duty cycle ≤ 2%; pulse width limited by max. junction temperature.
 ② Limited by T_{Jmax}, starting T_J = 25°C, L = 0.5mH,R_G = 25Ω, I_{AS} =60A, V_{GS} =10V.

Typical Characteristics

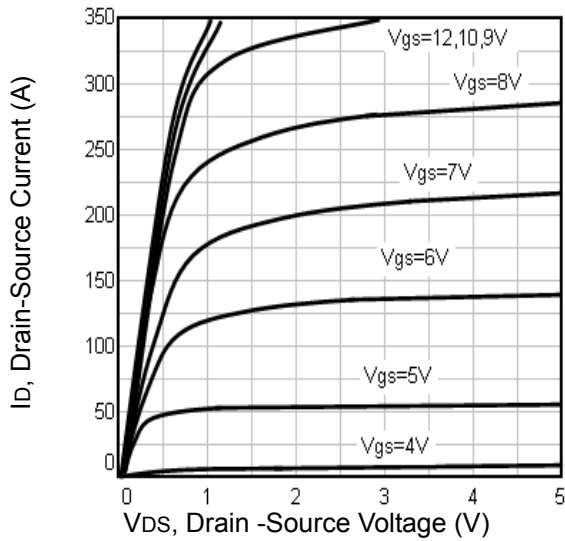


Fig1. Typical Output Characteristics

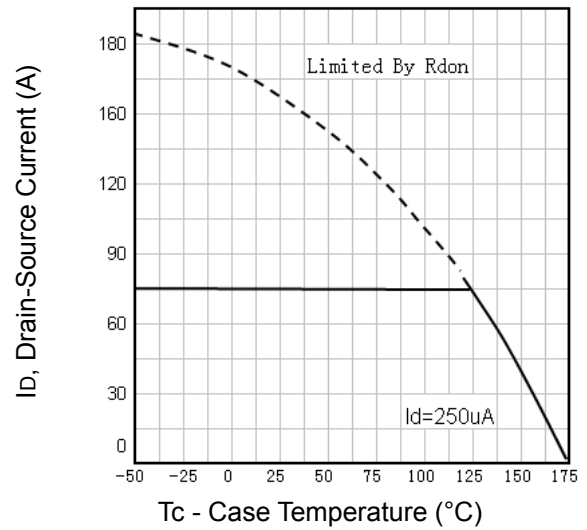


Fig2. Maximum Drain Current Vs. Case Temperature

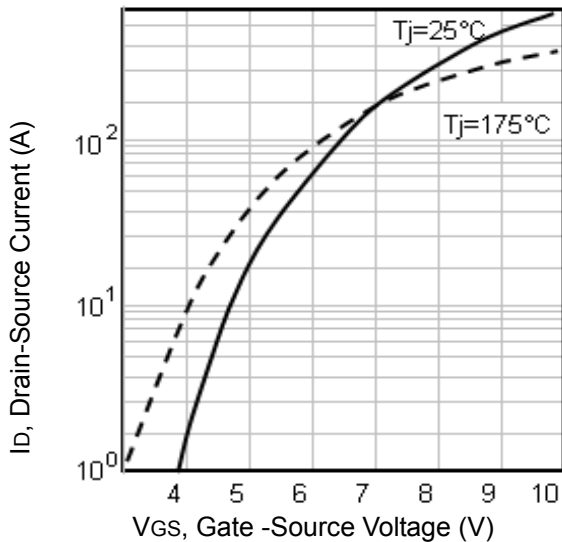


Fig3. Typical Transfer Characteristics

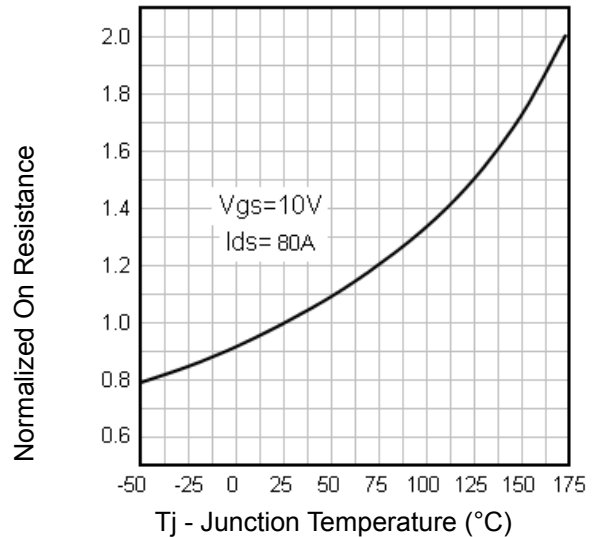


Fig4. Normalized On-Resistance Vs. Temperature

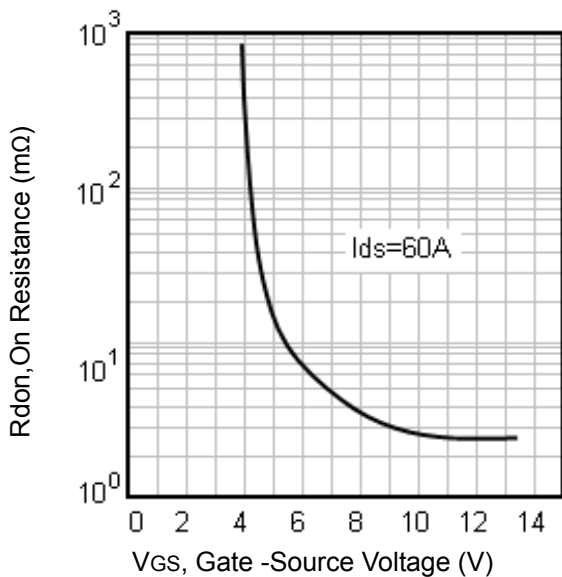


Fig5. Typical Forward Transconductance Vs. Drain Current

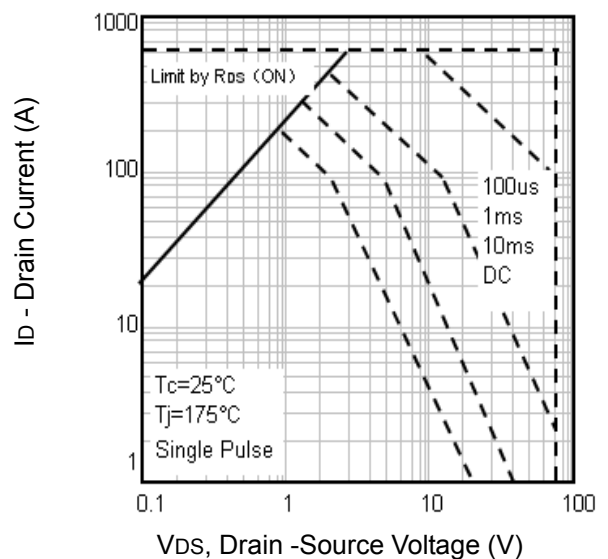


Fig6. Maximum Safe Operating Area

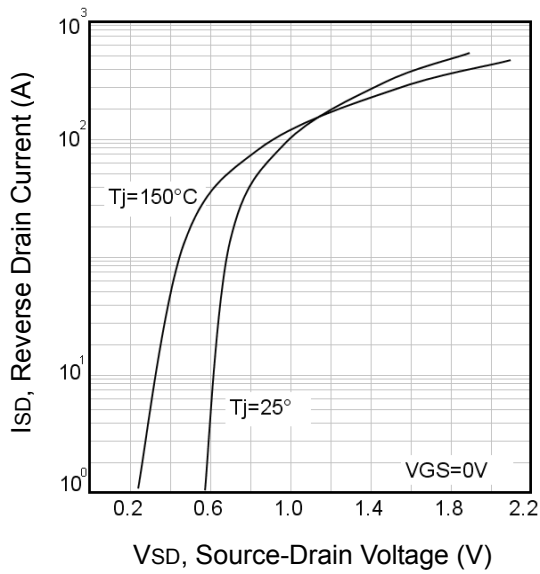


Fig7. Typical Source-Drain Diode Forward Voltage

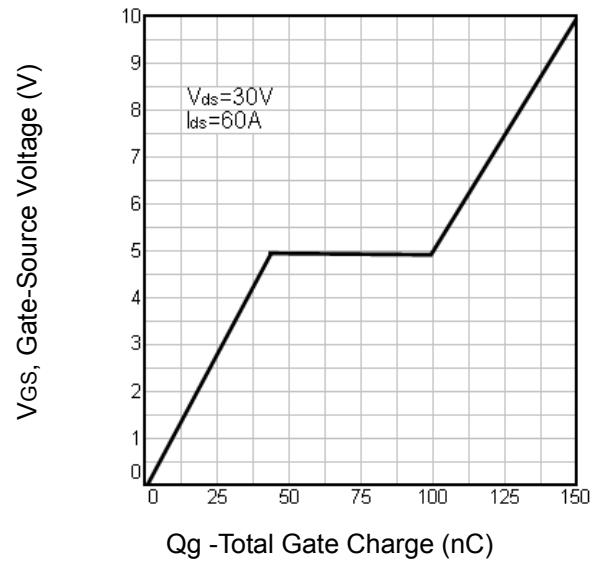


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

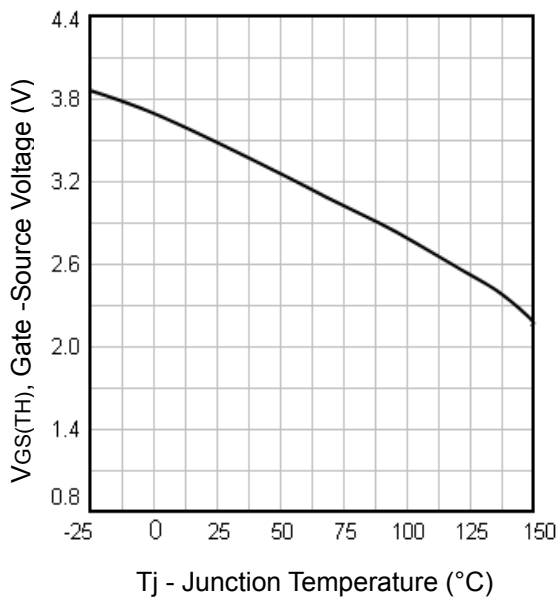


Fig9. Threshold Voltage Vs. Temperature

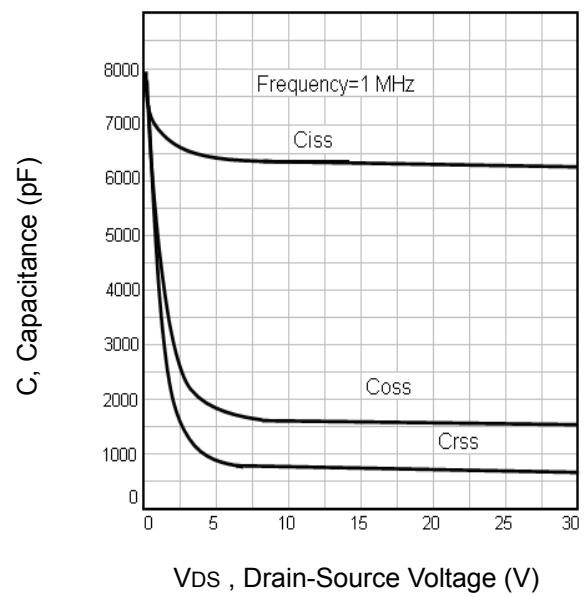


Fig10. Typical Capacitance Vs. Drain-Source Voltage

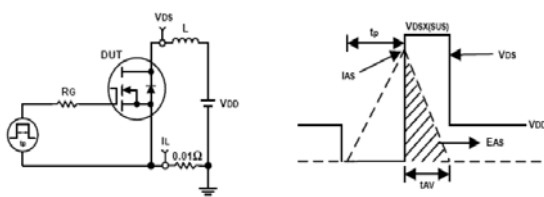


Fig11. Unclamped Inductive Test Circuit and waveforms

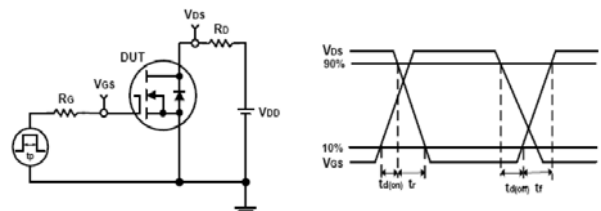
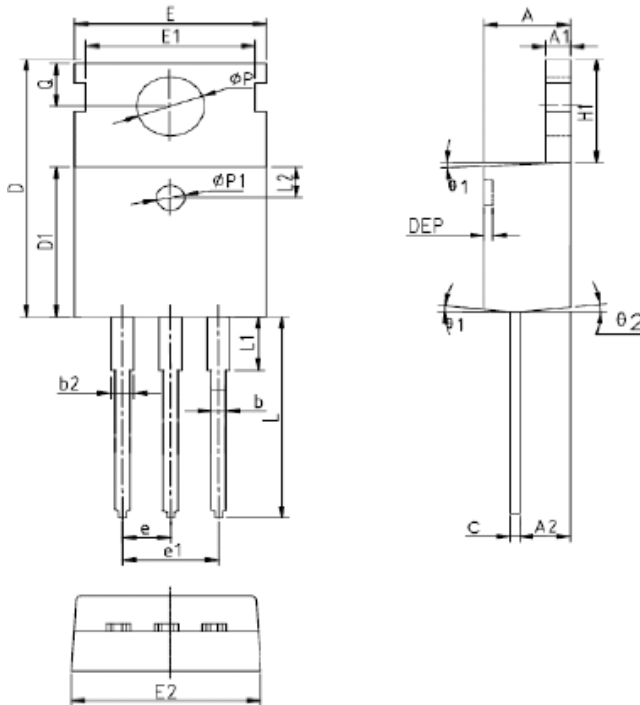


Fig12. Switching Time Test Circuit and waveforms

TO-220AB Package Outline



| SYMBOL | MM | | | INCH | | | SYMBOL | MM | | | INCH | | |
|--------|-------|-------|-------|-------|-------|-------|------------|----------|------|-------|-----------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX | | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 4.40 | 4.57 | 4.70 | 0.173 | 0.180 | 0.185 | $\phi p1$ | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 |
| A1 | 1.27 | 1.30 | 1.33 | 0.050 | 0.051 | 0.052 | e | 2.54BSC | | | 0.1BSC | | |
| A2 | 2.35 | 2.40 | 2.50 | 0.093 | 0.094 | 0.098 | e1 | 5.08BSC | | | 0.2BSC | | |
| b | 0.77 | - | 0.90 | 0.030 | - | 0.035 | H1 | 6.40 | 6.50 | 6.60 | 0.252 | 0.256 | 0.260 |
| b2 | 1.23 | - | 1.36 | 0.048 | - | 0.054 | L | 12.75 | - | 13.17 | 0.502 | - | 0.519 |
| C | 0.48 | 0.50 | 0.52 | 0.019 | 0.020 | 0.021 | L1 | - | - | 3.95 | - | - | 0.156 |
| D | 15.40 | 15.60 | 15.80 | 0.606 | 0.614 | 0.622 | L2 | 2.50REF. | | | 0.098REF. | | |
| D1 | 9.00 | 9.10 | 9.20 | 0.354 | 0.358 | 0.362 | ϕp | 3.57 | 3.60 | 3.63 | 0.141 | 0.142 | 0.143 |
| DEP | 0.05 | 0.10 | 0.20 | 0.002 | 0.004 | 0.008 | Q | 2.73 | 2.80 | 2.87 | 0.107 | 0.110 | 0.113 |
| E | 9.70 | 9.90 | 10.10 | 0.382 | 0.389 | 0.398 | $\theta 1$ | 5° | 7° | 9° | 5° | 7° | 9° |
| E1 | - | 8.70 | - | - | 0.343 | - | $\theta 2$ | 1° | 3° | 5° | 1° | 3° | 5° |
| E2 | 9.80 | 10.00 | 10.20 | 0.386 | 0.394 | 0.401 | | | | | | | |

Order Information

| Product | Marking | Package | Packaging | Min Unit Quantity |
|----------|----------|----------|------------|-------------------|
| VS3107AT | VS3107AT | TO-220AB | 50PCS/Tube | 1000PCS |

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